

TECHNICAL SPECIFICATION

IEC TS 61587-3

First edition
1999-10

Mechanical structures for electronic equipment – Tests for IEC 60917 and IEC 60297 –

Part 3: Electromagnetic shielding performance tests for cabinets, racks and subracks

*Structures mécaniques pour équipement électronique –
Essais pour la CEI 60917 et la CEI 60297 –*

*Partie 3:
Essais de fonctionnement de blindage électromagnétique
pour baies, bâtis et bacs à cartes*



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* See web site address on title page.

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International Electrotechnical Commission
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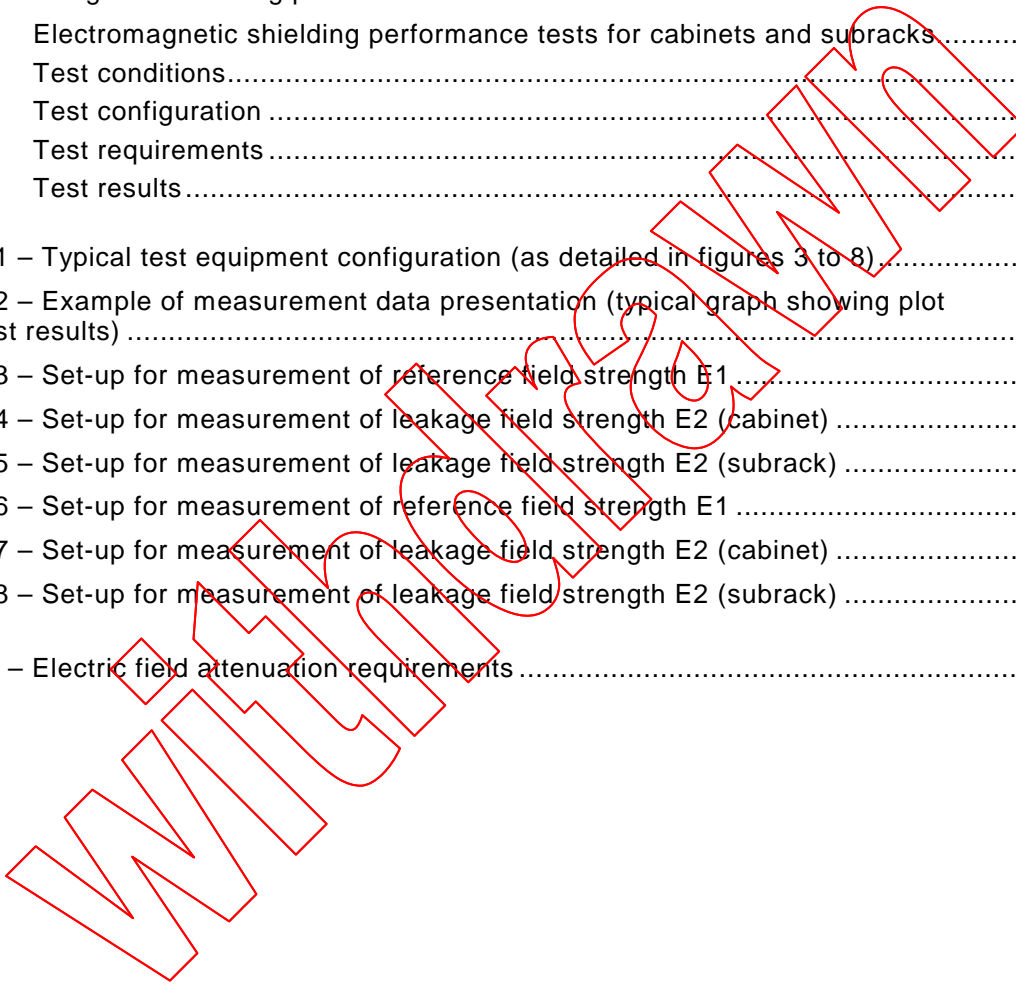
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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**MECHANICAL STRUCTURES FOR ELECTRONIC EQUIPMENT –
TESTS FOR IEC 60917 AND IEC 60297 –
Part 3: Electromagnetic shielding performance tests
for cabinets, racks and subracks**

FOREWORD

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- the required support cannot be obtained for the publication of an International Standard, despite repeated efforts, or
- the subject is still under technical development or where, for any other reason, there is the future but no immediate possibility of an agreement on an International Standard.

Technical specifications are subject to review within three years of publication to decide whether they can be transformed into International Standards.

IEC 61587-3, which is a technical specification, has been prepared by subcommittee 48D: Mechanical structures for electronic equipment, of IEC technical committee 48: Electro-mechanical components and mechanical structures for electronic equipment.

The text of this technical specification is based on the following documents:

Enquiry draft	Report on voting
48D/151/CDV	48D/183/RVC

Full information on the voting for the approval of this technical specification can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 3.

The committee has decided that this publication remains valid until 2003.

At this date, in accordance with the committee's decision, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

A bilingual version of this Technical Specification may be issued at a later date.

Withdrawn